HD6345/HD6445/ 专业PCB打样工厂, 24小时加

CRTC-II(CRT Controller)

The HD6345/HD6445 CRTC-II provides an interface between MPU and a raster scan CRT display. The HD6345 is upward-compatible with the NMOS CRTC HD6845S in pin and software, and has a 68 system bus interface. The HD6445 has a 80 system bus interface. A power dissipation is lowered by adopting the CMOS process.

The CRTC-II offers a variety of functions under MPU control, such as programmable timing signal outputs for CRT monitor and display screen control operation. It can be widely applied to the various types of CRT display systems.

FEATURES

FLEXIBLE SCREEN FORMAT

- Programmable numbers of characters per screen and rasters per character row
- Programmable horizontal/vertical sync signals and display timing signals
- Up to 16k words refresh memory (14-bit) addressable
- Programmable raster scanning modes: Non-Interlace, Interlace sync, or Interlace sync and video modes
- Up to 256 character rows per field
- High-speed display operation at 4.5 MHz character clock
- Double-size vertical display by raster interpolation

VERSATILE DISPLAY FUNCTIONS

- Screen split (max. 4 screens configurable, horizontally)
- Paging and scrolling for each screen
- Smooth scrolling
- Two cursors with programmable width
- Programmable refresh memoly width

FACILITATED SYSTEM CONFIGURATION

- 68 system bus interface (HD6345)
- 80 system bus interface (HD6445)
- Three-state control of memory address and raster address
- External synchronization in Master-slave or TV syne modes
- Interrupt request by vertical blanking or light pen strobe detection
- Programmable timing signal for dual-port RAM in MPRAM mode

PIN AND SOFTWARE UPWARD-COMPAT-IBLE WITH HD6845S

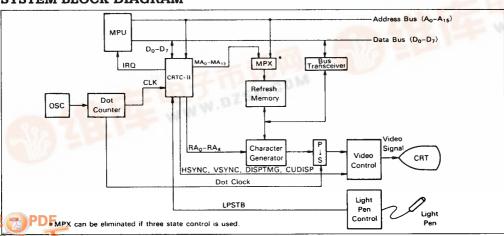
SINGLE-5V POWER SUPPLY

CMOS PROCESS

OPERATING TEMPERATURE SPECIFICA-TIONS

- Normal -20°C~+75°C
- J Version -40°C~+85°C

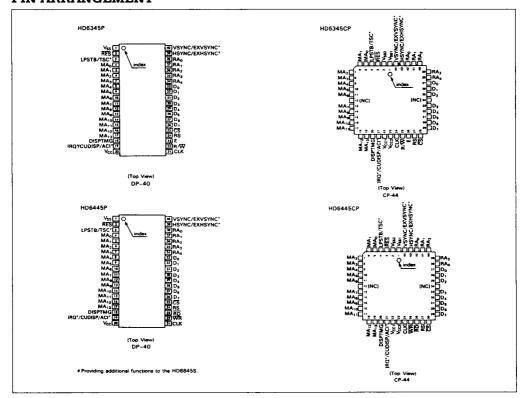
SYSTEM BLOCK DIAGRAM



TYPE OF PRODUCTS

Specification	Bus Interface	Type No.	Bus Timing	Package	CRT Display Timing
Normal	6800 system	HD6345P	1.0 MHz	DP-40 (40 pin	4.5 MHz (max)
	Bus interface	HD63A45P	1.5 MHz	plastic Dip)	
		HD63B45P	2.0 MHz	-	
		HD6345CP	1.0 MHz	CP-44	-
		HD63A45CP	1.5 MHz	(44 pin PLCC)	
		HD63B45CP	2.0 MHz	_	
	80 system	HD6445P4	4.0 MHz	DP-40	-
	Bus interface	HD6445CP4	•	CP-44	_
J version	6800 system	HD6345CPJ	1.0 MHz	CP-44	4.5 MHz (max)
(wide tempera-	Bus interface	HD63A45CPJ	1.5 MHz	_	
ture range)		HD63B45CPJ	2.0 MHz	-	
	80 system Bus interface	HD6445CP4J	4.0 MHz	_	

PIN ARRANGEMENT



PIN FUNCTION

F	Pin No.					
DP-40	CP-44	Symbol	Pin Name	Input/ Output	Functions	
1	1, 2	V _{SS} (V _{SS1} , V _{SS2})**	V _{SS}	_	Ground (GND) pin	
2	3	RES	Reset	Input	Performs external reset on CRTC-II RES assertion causes CRTC-II: (1) Clear all the internal counters (2) Set all the output signals at "L" (D ₀ -D ₇ are excluded.) (3) Clear registers R30 (Control 1), R31 (Control 2/Status), and R32 (Control 3) (Other registers are not affected at all) RES is valid only while LPSTB is "L"	
3	4	LPSTB	Light Pen Strobe	Input	Informs light pen strobe pulse detection	
		TSC	Three State Control	Input	Performs three-state control on memory and raster addresses	
4–17	5–11, 13–19	MA ₀ -MA ₁₃	Memory Address 0-13	Output	Supplies memory address for periodical memory refresh	
18	20	DISPTMG	Display Timing	Output	Indicates a screen display period	
19	21	CUDISP	Cursor Display	Output	Display cursor on a screen Enabled during DISPTMG is "H"	
		ACI	Access Inhibit	Output	Supplies MPRAM access inhibit timing (programmable)	
		IRQ	Interrupt Request	Output	Indicates interrupt request to MPU Enabled during DISPTMG is "L"	
20	22, 23	V _{CC} (V _{CC1} , V _{CC2})**	V _{CC}		Power supply (+ 5V) pin	
21	24	CLK	V _{CC} Character Clock	Input	Receives character clock timing	
22	25	R/W	Read/Write	Input	Controls data transfer direction between MPU and CRTC-II	
		WR*	Write	Input	Inputs write signal from MPU	
23	26	E	Enable	Input	Enables register read/write strobe signals from MPU	
		RD*	Read	Input	Inputs read signal from MPU	
24	27	RS	Register Select	Input	Selects either of address register or other registers Address reg. selected when at "L", and others at "H" Normally, requested to connect to "A ₀ " of MPU address bus	
25	28	ĊS	Chip Select	Input	Performs addressing on CRTC-II MPU Read/ write upon CRTC-II registers enabled when $\overline{\text{CS}}$ is "L"	
33-26	37–35, 33–29	D ₀ -D ₇	Data Bus 0-7	Input/ Output	Bidirectional bus for data transfer between MPU and CRTC-II	
38-34	42-38	RA ₀ -RA ₄	Raster Address 0-4	Output	Supplies raster address for selecting raster on character generator	
39	43	HSYNC	Horizontal Sync	Output	Supplies horizontal sync signal	
		EXHSYNC	External Horizontal Sync	Input	Receives external horizontal sync signal	
40	44	VSYNC	Vertical Sync	Output	Supplies vertical sync signal	
		EXVSYNC	External Vertical Sync	Input	Receives external vertical sync signal	

^{*}Notes: *Marked pins are of the HD6445.
**Marked pins are of the CP-44

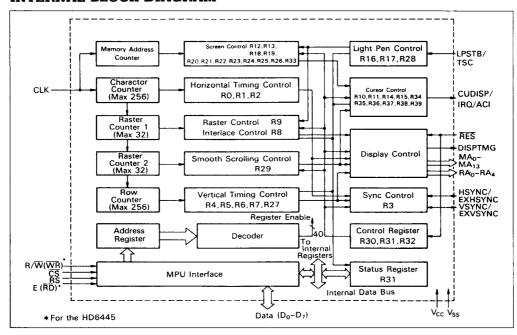
FUNCTION TABLE

Item	Descriptions	Remarks		
Programmable Screen Format	Horizontal scan cycle Vertical scan cycle (by row) Vertical scan cycle (Adjust) Number of displayed chars./row Number of char. rows/screen Number of rasters/char. row	Programmable by char. clock time Programmable by char. row time Programmable by raster time		
	Horizontal display position Vertical display position Vertical sync position (Adjust) HSYNC pulse width VSYNC pulse width	Enabled by programming sync signal output timings Programmable by raster time		
	DISPTMG skew	1 or 2 character skew		
Screen Split	4 split-screens start positions	Discretely programmable (Unit: row)		
	programmable	2/3/4 screens format selectable		
Cursor Control	Cursor display position	Two 14-bit cursor registers		
	Cursor height	1 or 2 cursors displayed Display start/end rasters program-		
	Cursor width Cursor blink Simultaneous output of 2 cursors (Only 1 availble in MPRAM mode)	mable within a row Programmable by char. clock time 1/16 or 1/32 field rate selectable Discretely programmable		
	Cursor display mode CUDISP skew	OR/EOR mode selectable 1 or 2 character skew		
Raster Scan Mode	Non-Interlace mode Interlace sync mode Interlace sync and video mode	Either one of three modes selectable		
Memory Format	Memory width set	Memory width programmable wider		
		than display width (Unit: char.)		
Smooth Scrolling	Display start raster address set Target screen set	Programmable by char, clock time Any screen selectable		
Raster Interpolation	Double-size vertical display Vertical scan cycle doubled	Same raster address supplied twice		
External Synchronization	Synchronization with external sync signals	Superimposed display enhabled on other CRT or TV screens		
Interrput Request	Interrupt request signal caused by vertical ratrace period or light pen detection (Disabled in MPRAM mode)	Interrupt regest mode programmable		
Light Pen	14-bit Light pen register Light pen raster register	Light pen raster address detected		
Refresh Memory Addressing	14-bit refresh memory address output Four 14-bit screen start address regs. (Display start address programmable	Up to 16k words refresh memory accessible Paging and scrolling enabled each		
Thurs Casas	for each screen)	screen		
Three-State Control	Three-state control on MA and RA	Controlled by TSC pin input		
Programmable Timing Output	Programmable timing signal supplied from access inhibit pin	In MPRAM mode		

CRTC-II NEWLY ADOPTED FEATURES

- 1. Screen Partition (horizontally split into 4 screens)
- 2. Smooth Scrolling
- 3. External Synchronization
- 4. Interrupt request
- 5. Raster Interpolation
- 6. Sync Position Adjustment
- 7. Light Pen Raster Address
- 8. Second Cursor
- 9. Display Momory Width Setting
- 10. 256 Rows Max
- 11. Timing Signal for MPRAM
- 12. Three-state Control of MA/RA Output

INTERNAL BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION

PROGRAMMABLE SCREEN FORMAT

Figure 1 illustrates the screen format example, in Non-Interlace mode, when programming CRTC-II registers as listed in Tabel 1. Figure 2 shows the relation between memory

address (MA_0 - MA_{13}), raster address (RA_0 - RA_4) and the location on the CRT screen.

The timing charts of CRT interface signals are shown in Figure 3, and those details are partially shown in Figure 4 and 5.



Tabel 1 Programmed Values in Each Register

	•		
Register No.	Register Name	Programmed Values	
RO	HORIZONTAL TOTAL CHARACTERS	Nht	
R1	HORIZONTAL DISPLAYED CHARACTERS	Nhd	
R2	HORIZONTAL SYNC POSITION	Nhsp	
R3	SYNC WIDTH	Nvsw, Nhsw	
R4	VERTICAL TOTAL ROWS	Nvt	
R5	VERTICAL TOTAL ADJUST	Nadj	
R6	VERTICAL DISPLAYED ROWS	Nvd	
R7	VERTICAL SYNC POSITION	Nvsp	
R9	MAX. RASTER ADDRESS	Nr	
R12	SCREEN 1 START ADDRESS (H)	0	
R13	SCREEN 1 START ADDRESS (L)	0	
R30	CONTROL 1	0	
R31	CONTROL 2/STATUS	0	
R32	CONTROL 3	0	

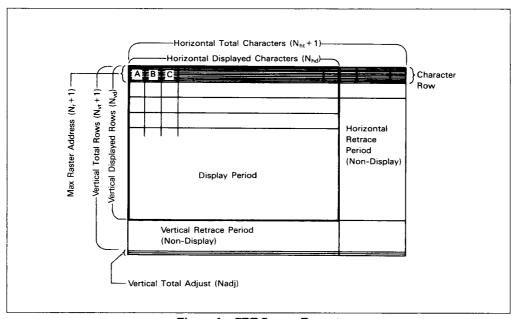
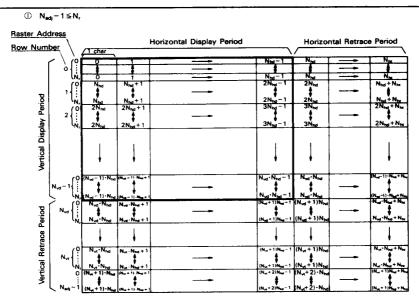
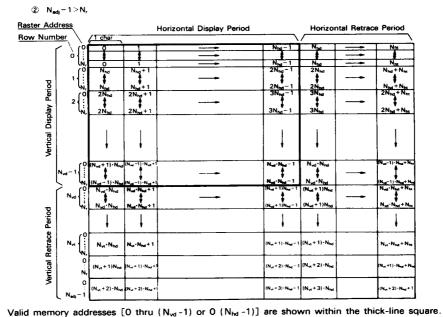


Figure 1 CRT Screen Format



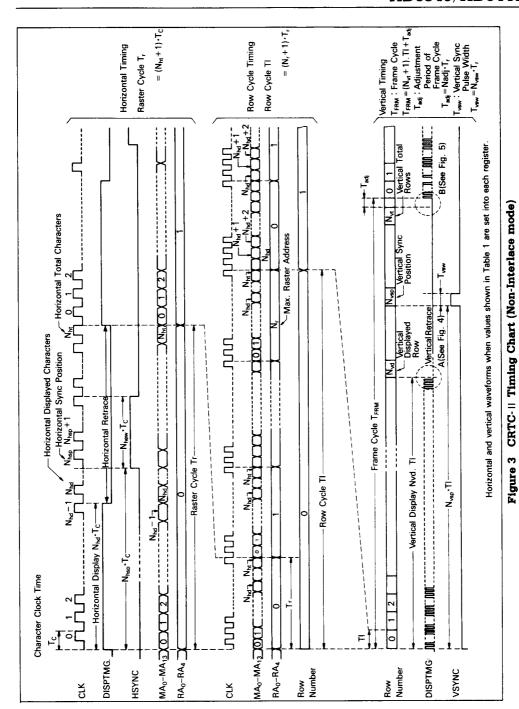
Valid memory addresses [0 thru (N_{vd} -1) or 0 (N_{hd} -1)] are shown within the thick-line square. Memory addresses are provided even during horizontal and vertical retrace period. This is an example in the case where the programmed value of start address register is 0.

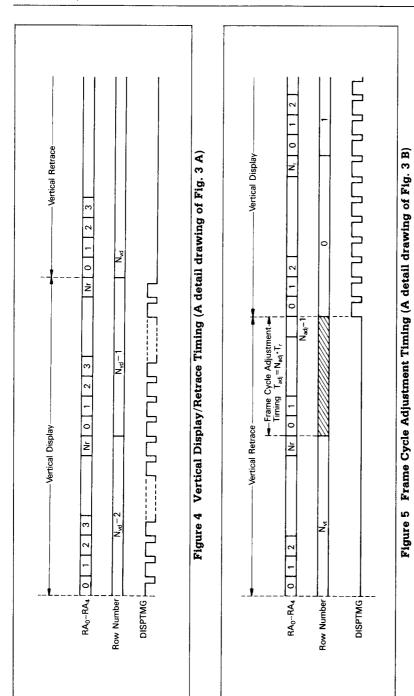


Memory addresses are provided even during horizontal and vertical retrace period. This is an example in the case where the programmed value of start address register is 0.

Figure 2 Memory Address and Raster Address

@HITACHI





SCREEN SPLIT

A display screen can be divided into up to four parts in the horizontal direction. Divided four parts are defined as split-screen 1, split-screen 2, split-screen 4.

The starting positions of each split-screen are determined in the number of character row. Split-screen 1 is the base screen, and always starts at row 0, while the other three split-screens start at any row except row 0. Paging or scrolling (by character) is performed in each split-screen independently.

Screen split is controlled by the SPO and the Sp1 bits of the control 1 register (R30) and the screen start position registers (R18, R21, R24). If the same value is programmed in more than one screen start position register or a start position which is out of display row is programmed in those registers, the corresponding split-screens will not be displayed.

The following is examples of screen split:

When the same value are programmed into more than one screen start position registers, split-screens corresponding to these registers are not displayed.

Table 2 Screen Split

Control 1 Register		Number of effective screen				
SP1	SP0	1	2	3	4	
0	0	0	-		_	
0	1	0	0	_	_	
1	0	0	0	0	_	
1	1	0	0	0	0	

: effective screen: invalid screen

Row Number	Display Screen	
0 1	Split-Screen 1	
2 3	Split-Screen 2	
4 5	Split-Screen 3	
6 7		
8	Split-Screen 4	

The programmed value of Screen 2 Start Position Register=1
The programmed value of Screen 3 Start Position Register=3
The programmed value of Screen 4 Start Position Register=7

Figure 6-A Screen Split (Example 1)

Row Number	Display Screen
0	
1	
2	
3	
4	Split-Screen 1
5	
6	
7	Split-Screen 4
8	

The programmed value of Screen 2 Start Position Register

= The programmed value of Screen 3 Start Position Register

The programmed value of Screen 4 Start Position Register = 6

Figure 6-B Screen Split (Example 2)

Row Number	Display Screen	
0		
1	Split-Screen 1	
2		
3		
4		
5	Split-Screen 4	
6		
7	Split-Screen 2	
8		

The programmed value of Screen 2 Start Position Register = 6
The programmed value of Screen 3 Start Position Register ≥ 8
The programmed value of Screen 4 Start Position Register = 4

Figure 6-C Screen Split (Example 3)

CURSOR CONTROL

The CRTC-II can display two separate cursors (cursor 1, cursor 2) simultaneously on the screen. These two cursors are controlled independently. The cursor 1 is always valid, while the cursor 2 becomes valid by setting the C_2 bit of the control 3 register (R32). In the MPRAM mode, the cursor 2 cannot be displayed. The CRTC-II controls cursors as

displayed. The CRTC-II controls cursors as follows:

1) Starting Position
Starting position is controlled by the cur-

sor 1 address registers (R14, R15), and the

- cursor 2 address registers (R36, R37).

 2) Cursor Heights

 The heights of the cursor 1 and the cursor
 2 can be specified independently in units
 of rasters by the cursor start registers
 (R10, R34), and the cursor end registers
 (R11, R35).
- 3) Cursor Widths

The widths of the cursor 1 and the cursor 2 can be specified independently in units of characters by the cursor width registers (R38, R39). The R38 register is enabled when 1 is set into the CW1 bit of the control 3 register (R32). The R39 register's enable bit is the CW2.

If the cursor width extends over the following row, the cursor in the following row will not be displayed.

- 4) Cursor Blink
 - Cursor display, non-display, and blink rate can be controlled by the bits B_1 and P_1 of the cursor 1 start register (R10), and bits the B_2 and P_2 of the cursor 2 start register (R34).
- 5) Cursor Display Mode
 When the cursor 1 and the cursor 2 are
 overlapped on the screen, cursor display
 mode in the overlapped area can be
 selected by the CM bit of the control 3
 register (R32), as shown in Figure 8.

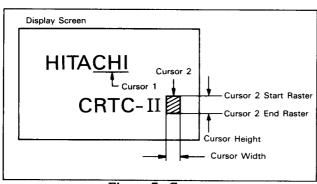


Table 3 Cursor Blink Mode

B ₁	P ₁	Cursor Blink Mode				
0	0	No blink				
0	1	No cursor				
1	0	Blink, 1/16 field rate				
1	1	Blink, 1/32 field rate				

Figure 7 Cursors

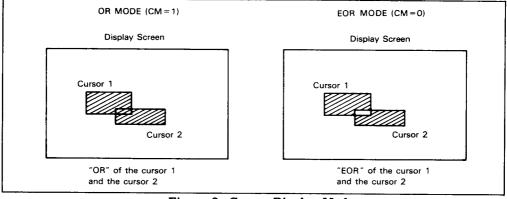


Figure 8 Cursor Display Mode



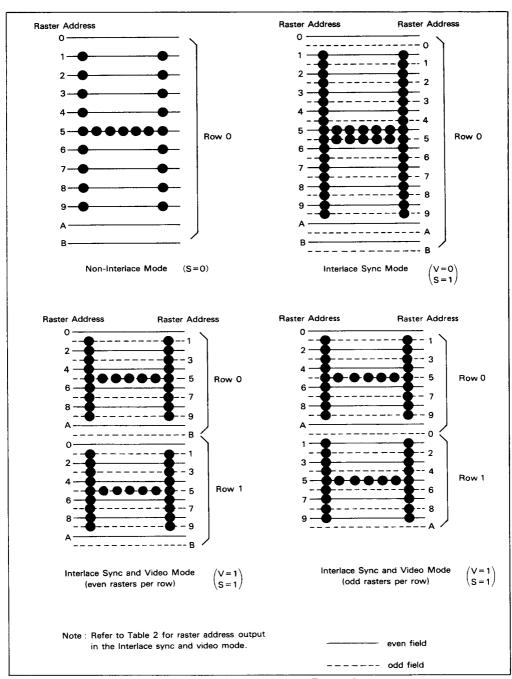


Figure 9 Raster Scanning Example

In the Interlace sync mode, the rasters in the odd field are placed downward by 1/2 raster line space from those in the even field because of the difference in HSYNC/VSYNC phases between two alternating fields.

In the Interlace sync and video mode, the placement of the rasters is the same as in the Interlace sync mode. However, the alternating even and odd resters are displayed in the alternating even and odd fields. Note that the raster address is supplied in the different way according to the total number of rasters in a row, even or odd, as shown in Table 4. Figure 9 illustrates the raster scanning example in each mode.

SMOOTH SCROLLING

Smooth scrolling in the vertical direction can be accomplished by changing the start raster address in a character row. Whether scrolling in each split-screen is available or not can be selected. Selected split-screens scroll in the same way up to four split-screens simultaneously.

Smooth scrolling is performed by the bits SS₁-SS₄ of the control 2 register (R31), and the smooth scrolling register (R29). It can be used in the Non-Interlace mode and the Interlace sync mode, but not in the Interlace sync and video mode.

Tabel 4 Start Raster Address for Each Row (In Interlace sync and video mode)

No. of Rasters	Field			
per Row	Even Field	Odd Field		
Even	Even address	Odd address		
Odd Even Char. Row* Odd Char. Row*	Even address Odd address	Odd address Even address		

^{*} The start row address is assumed to be 0 (even).

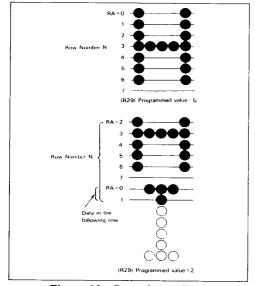


Figure 10 Smooth Scrolling

MEMORY WIDTH SETTING

The offset value is the difference between the display screen width and the display memory width in the horizontal direction. It can be specified in units of characters. (See Figure. 11)

Scrolling in any direction can be accomplished in units of characters, by setting the display memory width (horizontal direction) and the offset value, and by changing the start memory addresses. This is performed by the memory width offset register (R33) and the MW bit of the control 3 register (R32).

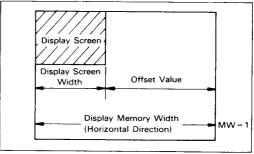


Figure 11 Memory Width

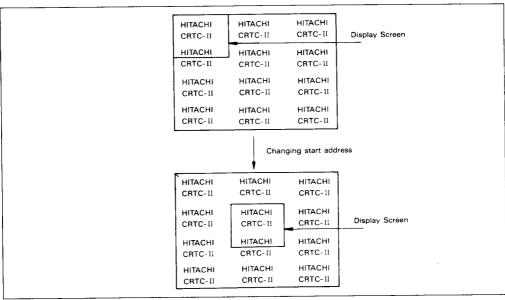


Figure 12 Scrolling by Memory Width Setting

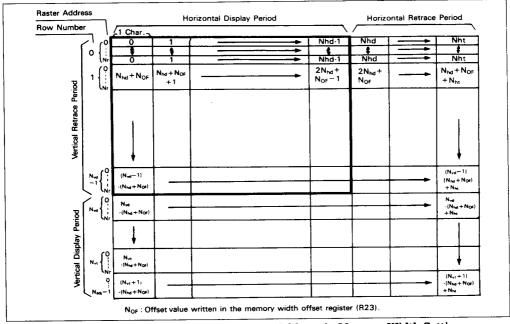


Figure 13 Memory Address and Raster Address in Memory Width Setting

RASTER INTERPOLATION

Raster interpolation function increments the raster address every two rasters, doubling the vertical scan cycle; thus the display image is doubled in the vertical direction.

Raster interpolation function is controlled by the RI bit of the control 2 register (R31). This function can be used in the non-interlace mode and the interlace sync mode, but not in the interlace sync and video mode. Figure 14 is a display example using raster interpolation function.

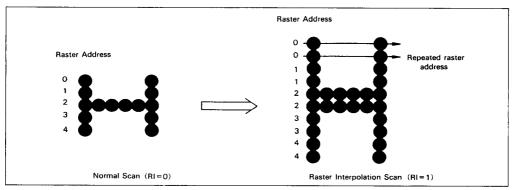


Figure 14 Raster Interpolation

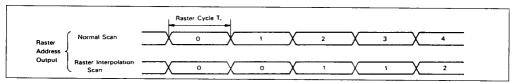


Figure 15 Raster Address Output and Raster Interpolation

EXTERNAL SYNCHRONIZATION

There are master/slave mode and TV sync mode in external synchronization.

The external synchronization is controlled by the bits VE, VS, and TV of the control 1 register (R30).

Master/slave mode is used to synchronize slave CRTC-IIs with a master CRTC-II by the VSYNC of a master CRTC-II. When superimposing a master screen with slave screen on the same CRT, clocks of a master and slave CRTC-IIs can operate in different frequency under conditions as follows.

- Phase of a master CRTC-II clock matches with a slave CRTC-II clock at rising edge of VSYNC.
- (2) Both master and slave CRTC-IIs have the same horizontal/vertical scan cycle.

Figure 16 illustrates the system configuration. In the Interlace sync mode and the Interlace

sync and video mode, the control 1 register must be set as to provide a VSYNC output in odd fields of a master CRTC-II.

TV sync mode is used to synchronize the CRTC-II with the HSYNC and VSYNC signals of a TV's video signal.

In the TV sync mode, the HSYNC/EXHSYNC pin inputs the EXHSYNC signal and the VSYNC/EXVSYNC pin inputs the EXVSYNC signal. The length of horizontal back porch is specified by the bits 0-3 of the sync width register (R3).

Figure 17 illustrates the system configuration.

In TV sync mode, when performing raster interpolation of slave CRTC-IIs, Interlace sync mode or Interlace sync and video mode must not be set in a master CRTC-II; this causes the screen moves up and down by one raster.

In the Interlace sync and video mode, the TV sync mode cannot be used.



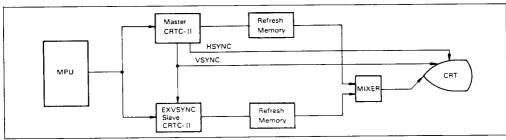


Figure 16 Master-Slave Mode

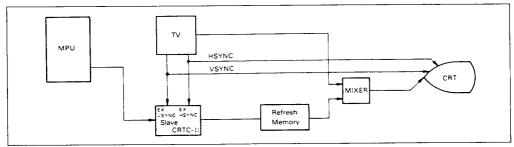


Figure 17 TV Sync Mode

Table 5 External Synchronization

						Function	
VE	vs	TV	Mode	EXHSYNC /HSYNC	EXVSYNC /VSYNC	DISPTMG	States
ō	0	0	Master /slave mode	OUTPUT	OUTPUT	Active	Set as master CRTC-II in master-slave mode. "000" is to be set when CRTC-II is in nomal states (HD6845 compatible mode) or master mode.
0	1	0	_			"Low"	Set as master CRTC-II in master slave mode. Display is inhibited by setting DISPTMG "0". VSYNC signal is supplied only in odd field scan except the non-interlace mode.
1	0	0	_	OUTPUT	INPUT	Active	Set as slave CRTC-II in master slave mode. EXHSYNC is not used for the synchronization.
1	1	0	_			"Low"	Set as slave CRTC-II in master slave mode. EXVSYNC is used for the synchronization.
0	0	1	TV sync mode	INPUT	OUTPUT	Active	Program inhibited
0	1	1	_			"Low"	Program inhibited
1	0	1	_	INPUT	INPUT	Active	Set as slave CRTC-II in TV sync mode. EXHSYNC, EXVSYNC inputs are used as sync signal.
1	1	1				"Low"	Set as slave CRTC-II in TV sync mode. Display is inhibited by setting DISPTMG "0". EXHSYNC, EXVSYNC inputs are used as sync signal.

Note: Slave CRTC-IIs are always Non-Interlace mode in TV sync mode.

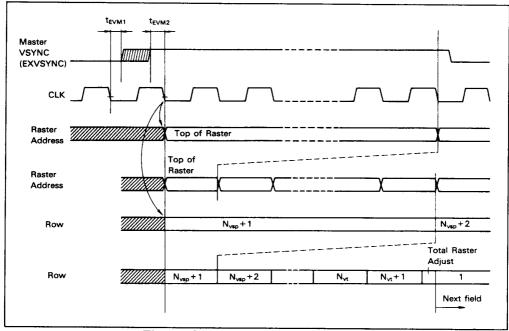


Figure 18 Synchronization Sequence

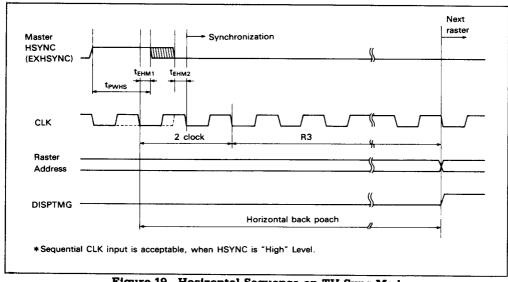
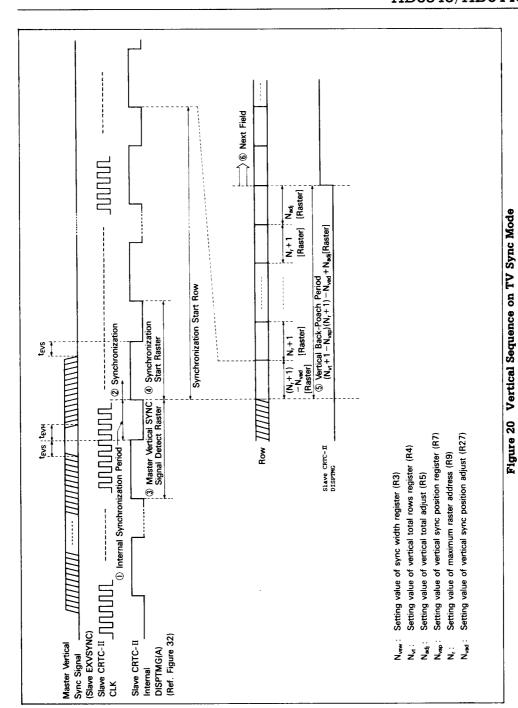


Figure 19 Hosizontal Sequence on TV Sync Mode



INTERRUPT REQUEST

An interrupt request signal to the MPU is output in the timing shown in Figure 21. Interrupt request is generated by the vertical retrace period, or the light pen input.

Reading the status register (R31) clears interrupt request signal. Thus, if the MPU does not read the status register (R31) when

an interrupt request is generated, an interrupt request signal is output during all the horizontal and vertical retrace periods.

In the MPRAM mode, an interrupt request signal is not output.

An interrupt request is controlled by the bits IB and IL of the control 1 register (R30).

Table 6 Interrupt Control

IB	IL	Source of Interrupt Request
0	0	None
0	1	Light pen strobe
1	0	Vertical retrace
1	1	Light pen strobe and/or vertical retrace

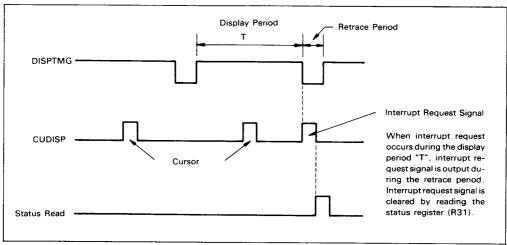


Figure 21 Interrupt Timing

THREE-STATE CONTROL OF MA/RA

Memory address (MA) and raster address (RA) outputs can be three-stated, using the TSC input pin. Three-state control is enabled by setting the TC bit of the control 3 register (R32).

When three-state control is used, a multiplexer (MPX) to select address lines from the MPU and the CRTC-II for refresh memory is not required, as shown in Figure 22.

MPRAM MODE

When the MPRAM mode is selected (DR=1), the HD6445 generates a programmable timing signal from the access inhibit pin. This signal, shown in Figure 23 as access inhibit period, provides the timing for the MPU to access to multi-port memory.

In the MPRAM mode, an interrupt request signal is not output, and the cursor 2 is not displayed.

This timing signal is controlled by the DR bit of the control 3 register (R32), and the cursor 2 width register (R39).

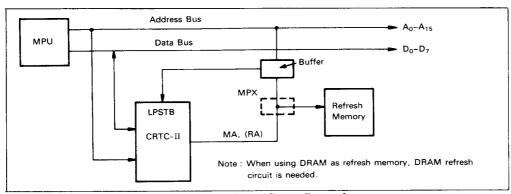


Figure 22 Three-State Control

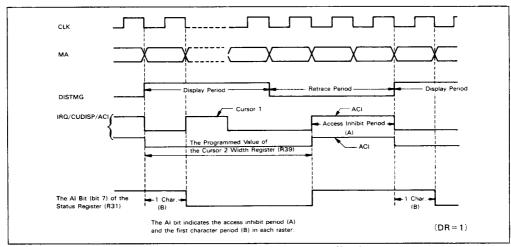


Figure 23 MPRAM Mode Output Timing

(1) HITACHI

SKEW

D ₁	Do	DISPTMG
0	0	No skew
0	1	One character skew
1	0	Two character skew
1	1	Not available ("Low" fixing)

C ₁	Co	CUDISP
0	0	No skew
0	1	One character skew
1	0	Two character skew
1	1	Not available ("Low" fixing)

LIGHT PEN

The R16 and R17 registers latches the light pen detection address. R28 register latches the light pen detection raster address and the detection period. The DP bit is set to 1 when the LPSTB is detected during the display period; cleared 0 during the retrace period.

VERTICAL SYNC POSITION ADJUST

The R27 register performs a fine adjustment to the vertical sync signal output in units of rasters. The VSYNC signal is supplied after the delay of Nvad rasters. R27 register is enabled when 1 is set into the SY bit of the control 1 register (R30).

STATUS

E	Status
0	During odd field display
1	During even field display
SB	Status
0	Not during vertical retrace
1	During vertical retrace
SL	Status
0	Light pen strobe not detected
1	Light pen strobe detected
AI	Status
0	Refresh memory access allowed
1	Refresh memory access inhibited

INTERNAL REGISTER ASSIGNMENT

		Register													
		Address	Reg.		Program			Dat	ta B	it					
CS	RS	543210	No.	Register Name	Unit	Symbo	tR/W	7	6	5	4	3	2	1	0
1	×	×××××	-		-	-	_	///							7777.
0	0	×××××	AR	ADDRESS REGISTER	_	_	W			,					
ō	1	000000	RO	HORIZONTAL TORAL CHARACTERS	character	Nht	W								
0	1	000001	R1	HORIZONTAL DISPLAYED CHARACTERS	character	Nhd	w								
0	1	000010	R2	HORIZONTAL SYNC POSITION	character	Nhsp	W								
0	1	000011	R3	SYNC WIDTH	*	Nvsw, Nhsw	W	Wv3	Wv ₂	Wv ₁	Wvo	Whg	Wh ₂	Wh	Who
0	1	000100	R4	VERTICAL TORAL ROWS	row	Nvt	W								
0	1	000101	R5	VERTICAL TORAL ADJUST	raster	Nadj	W								
0	1	000110	R6	VERTICAL DISPLAYED ROWS	row	Nvd	W								
ō	1	000111	R7	VERTICAL SYNC POSITION	row	Nvsp	W								
0	1	001000	R8	INTERLACE MODE AND SKEW	-	_	W	C ₁	Со	D ₁	Do			V	S
0	1	001001	R9	MAX RASTER ADDRESS	raster	Nr	W	///			<u>, </u>				
0	1	001010	R10	CURSOR 1 START	raster	Ncs ₁	W		В	P ₁					
0	1	001011	R11	CURSOR 1 END	raster	Nce ₁	W				//				
0	1	001100	R12	SCREEN 1 START ADDRESS (H)	memory address	-	R/W				*				_

- Note 1) *: Vertical: raster/Horizontal: character.
 - 2) ("0" is to be set, since these bits may be used in the future.

		Register Address	Reg.		Program			Dat	a Bi	t					
CS	RS	543210	No.	Register Name	Unit	Symbol	R/W	7	6	5	4	3	2	1	0
0	1	001101	R13	SCREEN 1 START ADDRESS (L)	memory address	-	R/W								
ō	1	001110	R14	CURSOR 1 ADDRESS (H)	memory address	_	R/W								
0	1	001111	R15	CURSOR 1 ADDRESS (L)	memory address	-	R/W	'							
0	1	010000	R16	LIGHT PEN (H)		_	R			/_					
0	1	010001	R17	LIGHT PEN (L)			R								
0	1	010010	R18	SCREEN 2 START POSITION	row		R/W	'		,					
0	1	010011	R19	SCREEN 2 START ADDRESS (H)	memory address	-	R/W								
0	1	010100	R20	SCREEN 2 START ADDRESS (L)	memoey address	-	R/M	'							· - ·
0	1	010101	R21	SCREEN 3 START POSTION	row	_	R/M								
0	1	010110	R22	SCREEN 3 START ADDRESS (H)	memory address	-	R/M								
0	1	010111	R23	SCREEN 3 START ADDRESS (L)	memory address	-	R/M	1							
0	1	011000	R24	SCREEN 4 START POSITION	row	-	R/M	/							
0	1	011001	R25	SCREEN 4 START ADDRESS (H)	memory address	-	R/M								
ō	1	011010	R26	SCREEN 4 START ADDRESS (L)	memory address	-	R/W	<i>I</i>							
0	1	011011	R27	VERTICAL SYNC POSITION ADJUST	raster	Nvad	W				//_				
0	1	011100	R28	LIGHT PEN RASTER			R	DP	M		<u>//</u>				
0	1	011101	R29	SMOOTH SCROLLING	raster	Nss	R/M	1///			<u>//</u>				
0	1	011110	R30	CONTROL 1	-	-	W	VE	VS	IB	IL.	SY	T۷	SP	SP0
0	1	011111	R31	CONTROL 2	_	_	W	SS	4 \$\$	3 S	s ₂ \$8	ı Ri			
				STATUS	_	_	R	At		///			E	SB	SL
0	1	100000	R32	CONTROL 3	-		W	CM	1 C ₂	C	W ₁ CV	/ ₂ MW	TC	DR	
0	1	100001	R33	MEMORY WIDTH OFFSET	character	Nof	R/W		,,_						
0	1	100010	R34	CURSOR 2 START	raster	Ncs ₂	W		∕ β2	P;	2				
0	1	100011	R35	CURSOR 2 END	raster	Nce ₂	W				//				
ō	1	100100	R36	CURSOR 2 ADDRESS (H)	memory address	_	R/M								
0	1	100101	R37	CURSOR 2 ADDRESS (L)	memory address	-	R/M	'							
0	1	100110	R38	CURSOR 1 WIDTH	characte	Ncw ₁	R/M	/							
0	1	100111	R39	CURSOR 2 WIDTH	characte	r Ncw ₂	R/M								

Note

*: Vertical: raster/Horizontal: character.
 \(\sum_{\text{in}} \): "0" is to be set, since these bits may be used in the future.

RESET

The RES functions as a reset input signal only while the LPSTB is "L". "Reset" is definable in two stages.

- (1) "During a reset state" indicates the period that the RES remains "L".
- (2) "After a reset state" indicates the state after the \overline{RES} transition from "L" to "H".

The pin status during a reset state is in Table

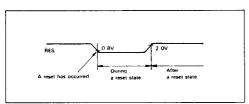


Figure 24 Reset Definition

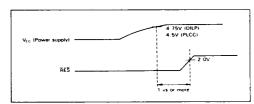


Figure 25 Reset at Power-on

Table 7 Pin Status during a Reset State

Pin No.				Input/	
DP-40	CP-44	Symbol	Pin Name	Output	Pin Status
1	1, 2	V _{SS} (V _{SS} 1, V _{SS} 2)**	Vss	_	
2	3	RES	RESET	Input	_
3	4	LPSTB	LIGHT PEN STROBE	Input	"L" level signal requested to
		TSC	THREE STATE CONTROL	Input	be supplied
4-17	5-11 13-19	MAO-MA13	MEMORY ADDRESS 0-13	Output	Goes "L" immediately after reset
18	20	DISPTMG	DISPLAY TIMING	Output	Goes "L" immediately after reset
19	21	CUDISP	CURSOR DISPLAY	Output	Goes "L" immediately after
		ACI	ACCESS INHIBIT	Output	reset
		IRQ	INTERRUPT REQUEST	Output	
20	22, 23	Vcc (Vcc1, Vcc2)**	Vcc	_	_
21	24	CLK	CHARACTER CLOCK	Input	Not affected
22	25	R/W (WR)*	READ/WRITE (WRITE)*	Input	Not affected
23	26	E (RD)*	ENABLE (READ)*	Input	Not affected
24	27	RS	REGISTER SELECT	Input	Not affected
25	28	CS	CHIP SELECT	Input	Not affected
33-26	37-35 33-29	D0-D7	DATA BUS 0-7	Input/ Output	Not affected
38-34	42-38	RAO-RA4	RASTER ADDRESS 0-4	Output	Goes "L" immediately after reset
39	43	HSYNC	HORIZONTAL SYNC	Output	Outputs HSYNC signal until
		EXHSYNC	EXTERNAL HORIZONTAL SYNC	Input	external sunch mode is set into the control 1 register (R29) after reset
40	44	VSYNC	VERTICAL SYNC	Output	Outputs VSYNC signal until
		EXVSYNC	EXTERNAL VERTICAL SYNC	Input	external sync mode is set into the control 1 register (R29) after reset

Note: * marked pins are of the HD6445

* * marked pins are of the CP-44

ABSOLUTE MAXIMUM RATINGS

Item		Symbol	Rating	Unit
Supply Voltage		Vcc*	-0.3 to +7.0	v
Input Voltage		V _{in} *	-0.3 to V _{CC} +0.3	V
Operating Temperature		Topr	-20 to +75	.c
Storage Temperature		T _{stg}	-55 to +150	°C
Allowable Output Current	Data Bus	lo **	5	mA
	Others	-	3	mA
Total Allowable Output Current		ΣΙο ***	60	mA

- * This value is in reference to V_{SS}=0V.
- * * The allowable output current is the maximum current that may be drawn from, of flow out to, one output pin or one input/output common pin.
- * * * The total allowable output current is the toral sum of currents that may be drawn from, or flow out to, output pins or input/output common pin.

Note: Using an LSI beyond its maximum ratings may result in its permanent destruction. LSI's should usually be under recommended operating conditions.

Exceeding any of these conditions may adversely affect its reliability.

RECOMMENDED OPERATING CONDITIONS

	Symbol	Min	Тур	Max	Unit
DP-40	Vcc*	4.75	5.0	5.25	V
CP-44	_	4.5		5.5	_
	V _{IL} *	-0.3	_	0.8	V
	V _{IH} *	2.0	_	Vcc	٧
	Topr	-20	25	75	,C
		DP-40 V _{CC} * CP-44 V _{IL} * V _{IH} *	DP-40 V _{CC} * 4.75 CP-44 V _{IL} * -0.3 V _{IH} * 2.0	DP-40 V _{CC} * 4.75 5.0 CP-44 4.5 V _{IL} * -0.3 - V _{IH} * 2.0 -	DP-40 V _{CC} * 4.75 5.0 5.25 CP-44 4.5 5.5 V _{IL} * -0.3 - 0.8 V _{IH} * 2.0 - V _{CC}

^{*} This value is in reference to V_{SS} = 0V.

ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

(V_{CC}=5.0V ± 5 % (DILP), 5.0 ± 10 % (PLCC), V_{SS}=0V, T_a=-20 to +75°C (Normal) -40 to +85°C (J), unless otherwise noted)

Item		Symbol	Min	Typ*	Max	Unit	Test Conditions
Input High Level Voltage		V _{IH}	2.0		Vcc	V	
Input Low Level V	oltage	VIL	-0.3	_	0.8	V	
Input Leak Current	Input except D ₀ -D ₇	l _{in}	-2.5	_	2.5	μΑ	$V_{in} = 0$ to 5.25 V
Three-State (Off State) Input Current	D ₀ -D ₇ Memory Address Raster Address	I _{TSI}	-10		10	μА	$V_{in} = 0.4 \text{ to } 2.4 \text{ V}$ $V_{CC} = 5.25 \text{ V}$
Output High	D ₀ -D ₇	Voh	2.4	_	_	V	I _{OH} = -205 μA
Level Voltage	Others	_					I _{OH} = -100µA
Output Low Level	Voltage	VoL	_		0.4	V	I _{OL} = 1.6mA
Input Capacity	D ₀ -D ₇ EXVSYNC EXHSYNC	C _{in}		_	12.5	pF	V _{in} = 0 V T _a = 25°C f = 1.0 MHz
	Others	**-		_	10	pF	
Output Capacity		C _{out}	_	_	10	pF	V _{in} =0 V T _a =25 °C f=1.0 MHz
Power Dissipation	No Load	P _D	_	50	100	mW	f _{CLK} =4.5 MHz
	Test Load			100	200		$f_E = 2.0 \text{ MHz}$ $V_{CC} = \text{max}$ $V_{IH} = V_{CC} - 1.0 \text{ V}$ $V_{IL} = 0.8 \text{ V}$

^{*} $T_a = 2.5^{\circ}C$, $V_{CC} = 5.0 \text{ V}$

AC CHARACTERISTICS ($V_{CC}=5.0V~\pm5~\%$ (DILP), 5V $\pm10~\%$ (PLCC), $V_{SS}=0V$, $T_a=-20$ to $+75^{\circ}C$ (Normal), -40 to $+85^{\circ}C$ (J), unless otherwise noted.)

1. Timing of CRT control signal

Symbol	Min	Тур	Max	Unit	Reference Figure
tcycC	220		_	ns	Fig. 26
PW _{CH}	100	-	-	ns	
PW _{CL}	100		-	ns	
ter, tef	_		20	ns	
t _{MAD}	-	_	80	ns	
t _{RAD}	_	_	80	ns	
t _{DTD}	_	-	120	ns	
tcoo	-		120	ns	
t _{HSD}	-	_	100	ns	
tvsp	15*	_	120	пѕ	
PWLPH	60	_	-	ns	
t _{LPD1}	_	_	70	ns	Fig. 28
t _{LPD2}	_	-	0	ns	Fig. 29
tmaz	-		50	ns	Fig. 27
t _{RAZ}	_	_	50	ns	
	tcycC PWch PWcL tcr, tcf tmad trad todd tcod thsd tvsd PWlph tlpd1 tlpd2 tmaz	tcycC 220 PWCH 100 PWCL 100 tcr, tcf - tMAD - tRAD - tDTD - tCDD - tHSD - tVSD 15* PWLPH 60 tLPD1 - tLPD2 - tMAZ -	tcycC 220 - PWch 100 - PWcl 100 - tcr, tcf - tmad - tdd - tcdd -	tcycC 220 PWch 100 PWcl 100 tcr, tcf 20 tmad 80 tdd 120 tcdd 120 tcdd 120 tksd 100 tvsd 15* - 120 PWlph 60 tlpd 70 tlpd 0 tmaz - 50	tcycC 220 - ns PWch 100 - ns PWcl 100 - ns tcr, tcf - 20 ns tmad - 80 ns tand - 120 ns tcdd - 120 ns tusd - 70 ns tusd - 70 ns tusd - 70 ns tupd - 70 ns tupd - 70 ns

Note*: Application after mark 7C1

2. External sync timing

Symbol	Min	Тур	Max	Unit	Reference Figure
tpwvs	2·t _{cyc} C	_	_	ns	Fig. 32
t _{vr}	-	-	20	ns	_ `
t _{vf}	_	-	20	ns	
t _{EVM1}	10	+	_	ns	Fig.30
t _{EVM2}	60	_		ns	
tpwns	2·t _{cyc} C	-		ns	Fig.31
t _{Hr}	_	_	20	ns	
t _{Hf}		_	20	ns	—Fig.32
t _{EHT1}	30	_	_	ns	_
t _{EHT2}	50	_	_	ns	
tevs	50	_	_	ns	
tevh	50	_	_	ns	
	tpwvs tvr tvf tevm1 tevm2 tpwhs thr thf tehT1 tehT2 tevs	tpwvs 2·tcycC tvr — tvf — tevm1 10 tevm2 60 tpwhs 2·tcycC thr — thr — teht1 30 teht2 50 tevs 50	tpwvs 2·tcycC - tvr tyf tevm1 10 - tevm2 60 - tpwhs 2·tcycC - thr thf teht1 30 - teht2 50 - teht2 50 - tevs 50 -	tpwvs 2·t _{cyc} C - - tvr - - 20 tvf - - 20 teVM1 10 - - teVM2 60 - - tpwhs 2·t _{cyc} C - - thr - - 20 thf - - 20 teHT1 30 - - teHT2 50 - - teVs 50 - -	tpwvs 2·tcycC - ns tvr - - 20 ns tvf - - 20 ns tevM1 10 - - ns tevM2 60 - - ns tpwhs 2·tcycC - ns thr - - 20 ns thf - - 20 ns teht1 30 - - ns teht2 50 - - ns tevs 50 - - ns

Note * : Normal application add input over 1H (One raster period)

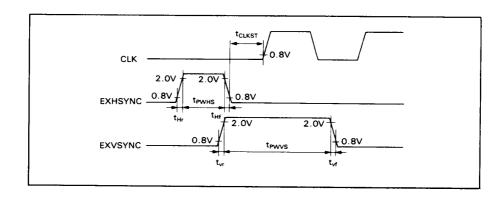
The above specification is applied after mark 7C1.

The following specification is applied before it.

The above specification is upward-compatible with the following specification.

External sync timing

Item	Symbol	Min	Тур	Max	Unit
Clock Halt Time	tclkst	100	_		ns
External Horizontal Sync Pulse Width	tpwns	1000	_		ns
External Horizontal Sync Rise and Fall Time	t _{Hr}	_	_	20	ns
	t _{Hf}	-	-	20	ns
External Vertical Sync Pulse Width	tpwvs	1660	_	_	ns
External Vertical Sync Rise and Fall Time	t _{Vr}	_	_	20	ns
	t _{Vf}	_	_	20	ns



3. MP Bus Timing

(1) HD6345 MPU bus timing

		6345	5	63A4	63A45		5		Reference Figure Fig. 33 Fig. 34
Item	Symbol	Min	Max	Min	Max	Min	Max	Unit	Figure
Enable Cycle Time	tcycE	1000	_	666	_	500	_	ns	Fig. 33
Enable High Pulse Width	PW _{EH}	450	_	280		220		ns	Fig. 34
Enable Low Pulse Width	PW _{EL}	400	_	280	-	210	_	ns	
Enable Rise and Fall Time	t _{Er} , t _{Ef}	_	20	-	20	_	20	ns	_
Address Setup Time	tas	80	_	80		40	_	ns	_
Data Setup Time	tosw	195	-	80	_	60		ns	_
Data Delay Time	toda	-	200	_	140	_	120	ns	
Data Hold Time	t _H	10	_	10	_	10	-	ns	
Address Hold Time	t _{AH}	10	-	10	_	10		ns	
Data Access Time	tACC		280	_	220		160	ns	
Input Signal Rise and Fall Time (RES, LPSTB, RS, CS, R/W)	tr, tf	-	100	-	100	-	100	ns	

(2) HD6445 MPU bus timing

Item	Symbol	Min	Тур	Max	Unit	Reference Figure
Read Address Setup Time	t _{AR}	0		_	ns	Fig. 35
Read Low Level Time	t _{RR}	160	=	-	ns	Fig. 36
Read Address Hold Time	t _{RA}	0	-	-	ns	_
Write Address Setup Time	t _{AW}	0	-	_	ns	
Write Low Level Time	tww	190	_	_	ns	_
Write Address Hold Time	t _{WA}	0	_	_	ns	
Data Delay Time	t _{RD}	_	_	120	ns	
Data Hold Time (Read)	t _{DF}	10	_	_	ns	
Data Setup Time	t _{DW}	60		_	ns	
Data Hold Time (Write)	t _{WD}	0	_		ns	
Access Inhibit Time	tois	210	_	_	ns	
Input Signal Rise Time, Fall Time (RES, LPSTB, RS, CS, RD, WR)	t _r t _f	_	_	100	ns	_

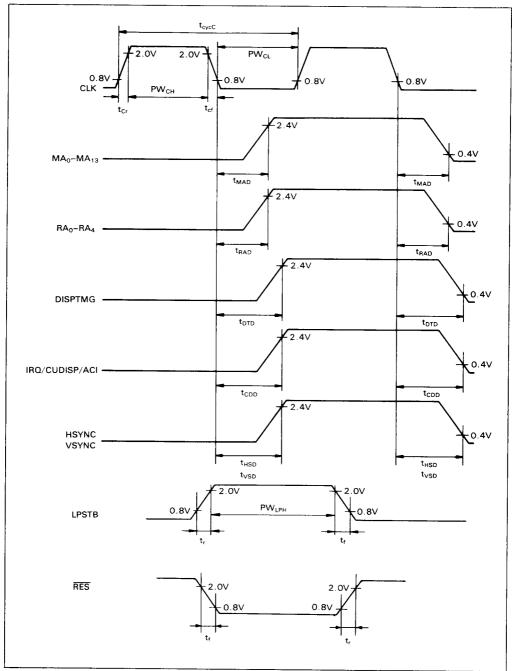


Figure 26 CRTC-II Timing Chart

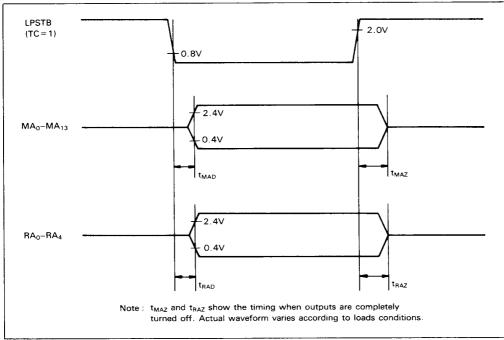


Figure 27 Three-State Delay Timing (Three-state mode: TC=1)

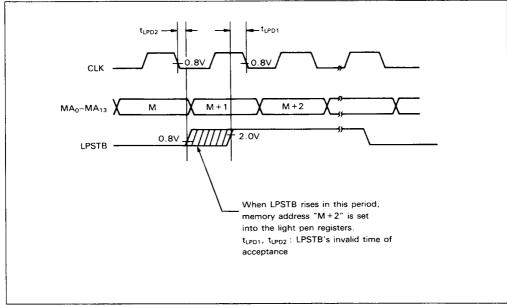


Figure 28 CRTC-II CLK, MA₀-MA₁₃, and LPSTB Timing

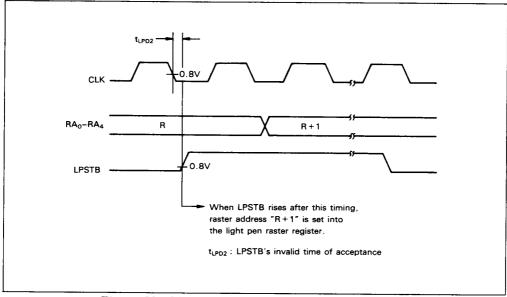


Figure 29 CRTC-|| CLK, RA₀-RA₄ and LPSTB Timing

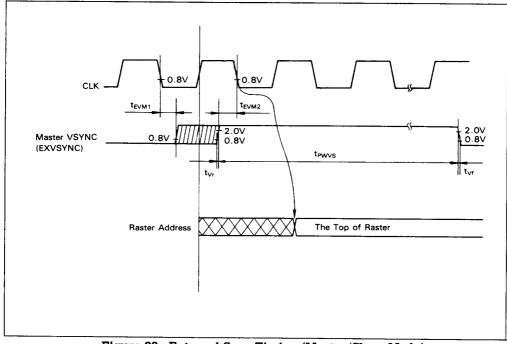
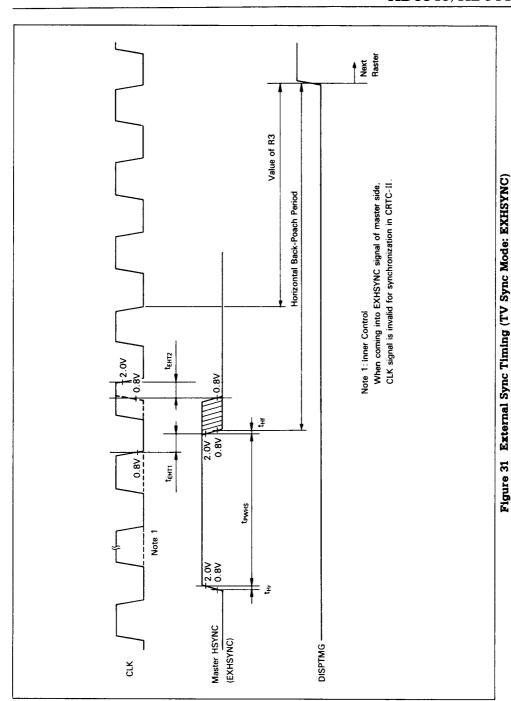


Figure 30 External Sync Timing (Master/Slave Mode)



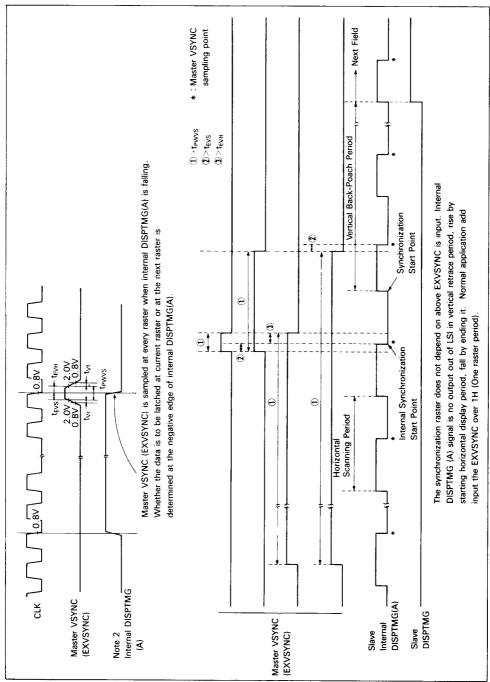


Figure 32-(a) External Sync Timing (TV Sync Mode: EXVSYNC)

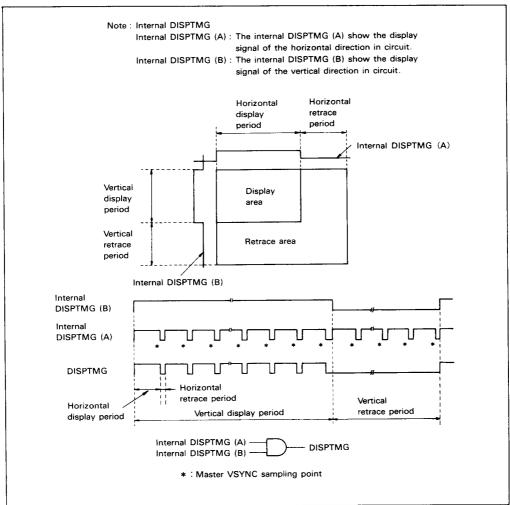


Figure 32-(b) External Sync Timing (TV Sync Mode: EXVSYNC)

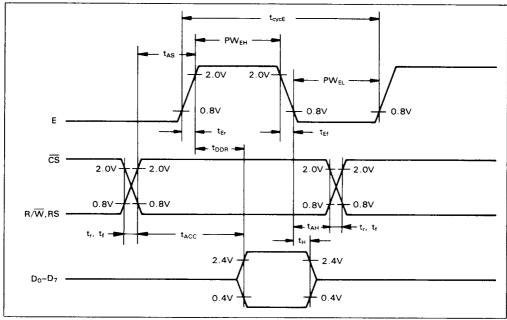


Figure 33 Read Sequence (HD6345)

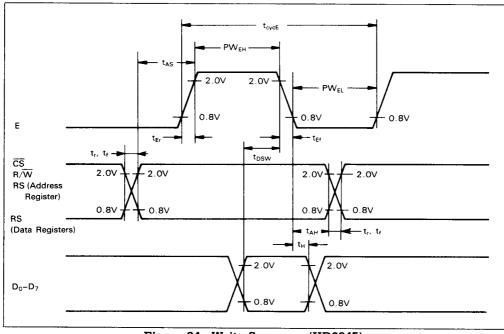


Figure 34 Write Sequence (HD6345)

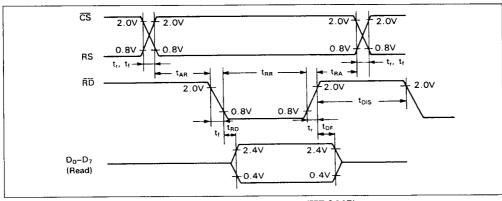


Figure 35 Read Sequence (HD6445)

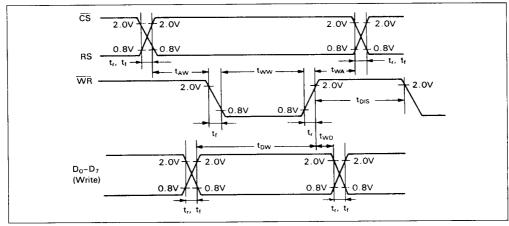


Figure 36 Write Sequence (HD6445)

TEST LOAD

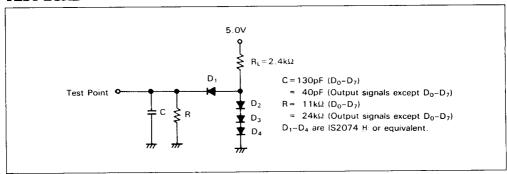


Figure 37 Test Load

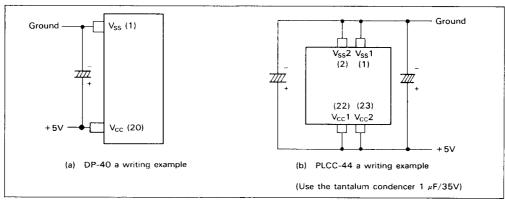


Figure 38 Note on Power Line Example

J SPECIFICATION

There is J specification in PLCC-44 of CRTC - II (HD6345/HD6445). J specification operat-

ing temperature is wider than normal specification operating temperature.

(1) Absolute maximum ratings

Item	Symbol	Rating	Unit	
Operating temperature	T _{opr}	-40 to +85	°C	

(2) Recommended operating conditions

		HD634	45 CPJ	5 CPJ				
Item	Symbol	min	typ	max	min	typ	max	Unit
Input high level voltage	V _{IH} *	CLK 2.2		Vcc	CLK WR RD 2.2	-	Vcc	V
		Other 2.0	_	Vcc	Other 2.0	_	Vcc	V
Operating temperature	Торг	-40	25	85	-40	25	85	·C

^{*} This value is in reference to $V_{SS} = 0 \text{ V}$.

(3) Electrical characteristics

		HD6345 CPJ			HD64			
Item	Symbol	min	typ	max	min	typ	max	Unit
Input high level voltage	V _{IH}	CLK 2.2	_	Vcc	CLK WR RI 2.2	<u> </u>	Vcc	V
		Other 2.0	_	Vcc	Other 2.0	-	Vcc	V

(4) Other item is the same normal specification items (Absolute Maximum Ratings,

Recommended Operating Conditions, Electrical Characteristics).

CHARACTERISTICS DIFFERENCES BETWEEN HD6345 AND HD6845S

			HD6345			HD684			
NO.	Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit
1	Power Dissipation	PD	_	50	_	_	600	1000	mW
2	Clock Cycle Time	tcycc	220	_	_	270			ns
3	Clock High Pulse Width	PW _{CH}	100	-		130	_	_	ns
4	Clock Low Pulse Width	PW _{CL}	100	_	_	130	_		ns
5	Memory Address Delay Time	tMAD	-	-	80	_	_	160	ns
6	Raster Address Delay Time	tRAD		-	80	_	_	160	ns
7	Display Timing Delay Time	t _{DTD}	-	-	120	-	_	250	ns
8	Horizontal Sync Delay Time	t _{HSD}	-	-	100	_		200	ns
9	Vertical Sync Delay Time	tvsp	_	-	120			250	ns
10	Cursor Display Delay Time	tcop	_		120	_	_	250	ns
11	Enable Cycle Time	tcyce	500	-	_	1000	_	_	ns
12	Enable High Pulse Width	PWEH	220	-	-	450	_	-	ns
13	Enable Low Pulse Width	PWEL	210	_		400	_	_	ns
14	Enable Rise and Fall Time	t _{Er} , t _{Ef}	_	-	20		_	_	ns
15	Address Set Up Time	tas	40	_	-	140	_	~	ns
16	Data Set Up Time	tosw	60	-		195		_	ns
17	Data Delay Time	t _{DDR}	_	_	120	_		320	ns
18	Data Access Time	tacc	-	_	160		_	460	ns
19	Input Signal Rise and Fall Time	t _r ,t _f	-		100		_	_	ns

CHARACTERISTICS DIFFERENCES BETWEEN HD6445 AND HD6845S

	HD6445							
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit
Power Dissipation	Po	-	50	-	_	500	1000	mW
Clock Cycle Time	tcycc	220	-	_	270	_	_	ns
Clock High Pulse Width	PWcH	100	_		130	_		ns
Clock Low Pulse Width	PW _{CL}	100		_	130	_	~	ns
Memory Address Delay Time	tMAD	_	_	80	_	_	160	ns
Raster Address Delay Time	tRAD	-	_	80			160	ns
Display Timing Delay Time	t _{DTD}	-	_	120	_	-	250	ns
Horizontal Sync Delay Time	tHSD	-	_	100	_	_	200	ns
Vertical Sync Delay Time	tvsp	-	-	120	_	_	250	ns
Cursor Display Delay Time	t _{CDD}	-	_	120			250	ns
	Power Dissipation Clock Cycle Time Clock High Pulse Width Clock Low Pulse Width Memory Address Delay Time Raster Address Delay Time Display Timing Delay Time Horizontal Sync Delay Time Vertical Sync Delay Time	Power Dissipation PD Clock Cycle Time tcycc Clock High Pulse Width PWcH Clock Low Pulse Width PWcL Memory Address Delay Time trans Raster Address Delay Time trans Display Timing Delay Time trans Horizontal Sync Delay Time trys Vertical Sync Delay Time trys	Item Symbol Min Power Dissipation PD — Clock Cycle Time tcycc 220 Clock High Pulse Width PWCH 100 Clock Low Pulse Width PWCL 100 Memory Address Delay Time tMAD — Raster Address Delay Time tRAD — Display Timing Delay Time tDTD — Horizontal Sync Delay Time tHSD — Vertical Sync Delay Time tVSD —	Item Symbol Min Typ Power Dissipation PD - 50 Clock Cycle Time tcycc 220 - Clock High Pulse Width PWCH 100 - Clock Low Pulse Width PWCL 100 - Memory Address Delay Time tMAD - - Raster Address Delay Time tRAD - - Display Timing Delay Time tDTD - - Horizontal Sync Delay Time tHSD - - Vertical Sync Delay Time tvsD - -	Item Symbol Min Typ Max Power Dissipation PD - 50 - Clock Cycle Time tcycc 220 - - Clock High Pulse Width PWCH 100 - - Clock Low Pulse Width PWCL 100 - - Memory Address Delay Time tMAD - - 80 Raster Address Delay Time tRAD - - 80 Display Timing Delay Time tDTD - - 120 Horizontal Sync Delay Time tHSD - - 100 Vertical Sync Delay Time tvsD - - 120	Item Symbol Min Typ Max Min Power Dissipation PD - 50 - - Clock Cycle Time tcycc 220 - - 270 Clock High Pulse Width PWCH 100 - - 130 Clock Low Pulse Width PWCL 100 - - 130 Memory Address Delay Time tMAD - - 80 - Raster Address Delay Time tRAD - - 80 - Display Timing Delay Time tDTD - - 120 - Horizontal Sync Delay Time tHSD - - 100 - Vertical Sync Delay Time tVSD - - 120 -	Item Symbol Min Typ Max Min Typ Power Dissipation PD - 50 - - 500 Clock Cycle Time tcycc 220 - - 270 - Clock High Pulse Width PWCH 100 - - 130 - Clock Low Pulse Width PWCL 100 - - 130 - Memory Address Delay Time tMAD - - 80 - - Raster Address Delay Time tRAD - - 80 - - Display Timing Delay Time tDTD - - 120 - - Horizontal Sync Delay Time tHSD - - 100 - - Vertical Sync Delay Time tysb - - 120 - -	Item Symbol Min Typ Max Min Typ Max Power Dissipation PD - 50 - - 500 1000 Clock Cycle Time tcycc 220 - - 270 - - Clock High Pulse Width PWcH 100 - - 130 - - Clock Low Pulse Width PWcL 100 - - 130 - - Memory Address Delay Time tMAD - - 80 - - 160 Raster Address Delay Time t _{RAD} - - 80 - - 160 Display Timing Delay Time t _{DTD} - - 120 - - 250 Horizontal Sync Delay Time t _{VSD} - - 120 - - 250

Refer to user's manual (No. ADE-602-006A), application note (No. ADE-502-004) for detail of this product.